

Chopper-Stabilized Precision Hall-Effect Latches

FEATURES AND BENEFITS

- AEC-Q100 automotive qualified
- Quality Managed (QM)
- Symmetrical latch switch points
- Resistant to physical stress
- Superior temperature stability
- Output short-circuit protection
- Operation from unregulated supply down to 3 V
- Reverse-battery protection
- Solid-state reliability
- Small package sizes

PACKAGES:

Not to scale

DESCRIPTION

The A1220, A1221, A1222, and A1223 Hall-effect sensor ICs are extremely temperature-stable and stress-resistant devices especially suited for operation over extended temperature ranges to 150°C. Superior high-temperature performance is made possible through dynamic offset cancellation, which reduces the residual offset voltage normally caused by device overmolding, temperature dependencies, and thermal stress. Each device includes on a single silicon chip a voltage regulator, Hallvoltage generator, small-signal amplifier, chopper stabilization, Schmitt trigger, and a short-circuit protected open-drain output to sink up to 25 mA. A south pole of sufficient strength turns the output on. A north pole of sufficient strength is necessary to turn the output off.

An onboard regulator permits operation with supply voltages of 3 to 24 V. The advantage of operating down to 3 V is that the device can be used in 3 V applications or with additional

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TYPICAL APPLICATIONS

• Automotive

- Power closures/actuators
- Electronic power steering
- Seat/windows/sunroof
- motors
- Industrial motor/encoders
- Commutation/index sensing
- BLDC motors
- Fan motors
- Trunk/door/liftgate motors
-

FUNCTIONAL BLOCK DIAGRAM

DESCRIPTION (continued)

external resistance in series with the supply pin for greater protection against high voltage transient events.

Two package styles provide magnetically optimized packages for most applications. Package type LH is a modified 3-pin SOT23W surface-mount package, while UA is a three-pin ultra-mini SIP for through-hole mounting. Both packages are lead (Pb) free, with 100% matte-tin-plated leadframes.

SELECTION GUIDE

[1] Contact Allegro for additional packing options.

[2] Available through authorized Allegro distributors only.

[3] The chopper-style UA package is not for new design; the matrix HD style UA package is recommended for new designs.

ABSOLUTE MAXIMUM RATINGS

[1] This rating does not apply to extremely short voltage transients such as Load Dump and/or ESD. Those events have individual ratings, specific to the respective transient voltage event.

PINOUT DIAGRAMS AND TERMINAL LIST TABLE

Terminal List

Chopper-Stabilized Precision Hall-Effect Latches A1220, A1221,

ELECTRICAL CHARACTERISTICS: Valid over full operating voltage and ambient temperature ranges, unless otherwise noted

[1] Typical data are are at T_A = 25°C and V_{CC} = 12 V, and are for initial design estimations only.

 $[2] 1 G (gauss) = 0.1 mT (millitesla).$

[3] Guaranteed by device design and characterization.

 $[4]$ C_L = oscilloscope probe capacitance.

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THERMAL CHARACTERISTICS: May require derating at maximum conditions; see application information

Temperature (ºC) **Power Dissipation versus Ambient Temperature**

Chopper-Stabilized Precision Hall-Effect Latches A1220, A1221,

CHARACTERISTIC PERFORMANCE A1220, A1221, A1222, and A1223 Electrical Characteristics

A1222, and A1223

Average Supply Current (Off) versus Temperature

Average Supply Current (On) versus Supply Voltage 0.0 0.5 1.0 1.5 2.0 2.5 3.0 3.5 4.0 4.5 5.0 5.5 6.0 2 6 10 14 18 22 26 V_{CC} (V) **Icc(AV)(mA) 150°C -40°C 25°C**

Average Supply Current (Off) versus Supply Voltage

Saturation Voltage versus Supply Voltage

Chopper-Stabilized Precision Hall-Effect Latches A1220, A1221,

A1220 Magnetic Characteristics

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Chopper-Stabilized Precision Hall-Effect Latches A1220, A1221,

A1221 Magnetic Characteristics

90 80 70 60 (°C) 50 ÷, **40 30 20 10 0 2 6 10 14 18 22 26**

Operate Point versus Supply Voltage

Release Point versus Supply Voltage

-70 -80 -90 -100 -110 -120 -130 -140 -150

BRP (G)

BHYS (G)

Chopper-Stabilized Precision Hall-Effect Latches A1220, A1221,

A1222 Magnetic Characteristics

 $+ 2.6$ **24 (V)**

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Release Point versus Temperature

-60 -40 -20 0 20 40 60 80 100 120 140 160 $T_A (°C)$

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Chopper-Stabilized Precision Hall-Effect Latches A1220, A1221,

FUNCTIONAL DESCRIPTION

OPERATION

The output of these devices switches low (turns on) when a magnetic field perpendicular to the Hall element exceeds the operate point threshold, B_{OP} (see panel A of figure 1). After turn-on, the output voltage is $V_{\text{OUT(SAT)}}$. The output transistor is capable of sinking current up to the short circuit current limit, I_{OM} , which is a minimum of 30 mA. When the magnetic field is reduced below the release point, B_{RP} , the device output goes high (turns off). The difference in the magnetic operate and release points is the hysteresis, B_{HYS} , of the device. This built-in hysteresis allows clean switching of the output even in the presence of external mechanical vibration and electrical noise.

Removal of the magnetic field will leave the device output latched on if the last crossed switch point is B_{OP} , or latched off if the last crossed switch point is B_{RP} .

Powering-on the device in the hysteresis range (less than B_{OP} and higher than B_{RP}) will give an indeterminate output state. The correct state is attained after the first excursion beyond B_{OP} or B_{RP} .

APPLICATIONS

It is strongly recommended that an external bypass capacitor be connected (in close proximity to the Hall element) between the supply and ground of the device to reduce both external noise and noise generated by the chopper stabilization technique. As is shown in panel B of figure 1, a 0.1 µF capacitor is typical.

Extensive applications information for Hall-effect devices is available in:

• *Hall-Effect IC Applications Guide*, Application Note 27701

- *Guidelines for Designing Subassemblies Using Hall-Effect Devices*, Application Note 27703.1
- *Soldering Methods for Allegro's Products SMT and Through-Hole*, Application Note 26009

All are provided in *Allegro Electronic Data Book*, AMS-702, and the Allegro website, www.allegromicro.com.

Figure 1. Switching behavior of latches. In panel A, on the horizontal axis, the B+ direction indicates increasing south polarity magnetic field strength, and the B– direction indicates decreasing south polarity field strength (including the case of increasing north polarity). This behavior can be exhibited when using a circuit such as that shown in panel B.

CHOPPER STABILIZATION TECHNIQUE

When using Hall effect technology, a limiting factor for switch point accuracy is the small signal voltage developed across the Hall element. This voltage is disproportionally small relative to the offset that can be produced at the output of the Hall element. This makes it difficult to process the signal while maintaining an accurate, reliable output over the specified operating temperature and voltage ranges.

Chopper stabilization is a unique approach used to minimize Hall offset on the chip. The Allegro technique, namely Dynamic Quadrature Offset Cancellation, removes key sources of the output drift induced by thermal and mechanical stresses. This offset reduction technique is based on a signal modulation-demodulation process. The undesired offset signal is separated from the magnetic field-induced signal in the frequency domain, through modulation. The subsequent demodulation acts as a modulation process for the offset, causing the magnetic field induced signal to recover its original spectrum at baseband, while the dc offset becomes a high-frequency signal. The magnetic sourced signal then can pass through a low-pass filter, while the modulated DC offset is suppressed. This configuration is illustrated in figure 2.

The chopper stabilization technique uses a 400 kHz high frequency clock. For demodulation process, a sample and hold technique is used, where the sampling is performed at twice the chopper frequency (800 kHz). This high-frequency operation allows a greater sampling rate, which results in higher accuracy and faster signal-processing capability. This approach desensitizes the chip to the effects of thermal and mechanical stresses, and produces devices that have extremely stable quiescent Hall output voltages and precise recoverability after temperature cycling. This technique is made possible through the use of a BiCMOS process, which allows the use of low-offset, low-noise amplifiers in combination with high-density logic integration and sample-and-hold circuits.

The repeatability of magnetic field-induced switching is affected slightly by a chopper technique. However, the Allegro high frequency chopping approach minimizes the affect of jitter and makes it imperceptible in most applications. Applications that are more likely to be sensitive to such degradation are those requiring precise sensing of alternating magnetic fields; for example, speed sensing of ring-magnet targets. For such applications, Allegro recommends its digital device families with lower sensitivity to jitter. For more information on those devices, contact your Allegro sales representative.

Figure 2. Model of chopper stabilization technique

POWER DERATING

The device must be operated below the maximum junction temperature of the device, $T_{J(max)}$. Under certain combinations of peak conditions, reliable operation may require derating supplied power or improving the heat dissipation properties of the application. This section presents a procedure for correlating factors affecting operating T_J . (Thermal data is also available on the Allegro MicroSystems website.)

The Package Thermal Resistance, $R_{\theta JA}$, is a figure of merit summarizing the ability of the application and the device to dissipate heat from the junction (die), through all paths to the ambient air. Its primary component is the Effective Thermal Conductivity, K, of the printed circuit board, including adjacent devices and traces. Radiation from the die through the device case, R_{BIC} , is relatively small component of $R_{\theta JA}$. Ambient air temperature, T_A , and air motion are significant external factors, damped by overmolding.

The effect of varying power levels (Power Dissipation, P_D), can be estimated. The following formulas represent the fundamental relationships used to estimate T_J , at P_D .

$$
P_D = V_{IN} \times I_{IN} \tag{1}
$$

$$
\Delta T = P_D \times R_{\theta J A} \tag{2}
$$

$$
T_J = T_A + \varDelta T \tag{3}
$$

For example, given common conditions such as: $T_A = 25^{\circ}C$, V_{CC} = 12 V, I_{CC} = 1.6 mA, and R_{θ JA} = 165°C/W, then:

$$
P_D = V_{CC} \times I_{CC} = 12 \text{ V} \times 1.6 \text{ mA} = 19 \text{ mW}
$$

$$
\Delta T = P_D \times R_{\theta J A} = 19 \text{ mW} \times 165^{\circ} \text{C/W} = 3^{\circ} \text{C}
$$

$$
T_J = T_A + \Delta T = 25^{\circ} \text{C} + 3^{\circ} \text{C} = 28^{\circ} \text{C}
$$

A worst-case estimate, $P_{D(max)}$, represents the maximum allowable power level ($V_{CC(max)}$, $I_{CC(max)}$), without exceeding $T_{J(max)}$, at a selected $R_{\theta JA}$ and T_A .

Example: Reliability for V_{CC} at $T_A = 150^{\circ}C$, package LH, using a minimum-K PCB.

Observe the worst-case ratings for the device, specifically: $R_{\theta JA}$ =228°C/W, $T_{J(max)}$ =165°C, V_{CC(max)} = 24 V, and $I_{CC(max)} = 4$ mA.

Calculate the maximum allowable power level, $P_{D(max)}$. First, invert equation 3:

$$
\Delta T_{max} = T_{J(max)} - T_A = 165^{\circ}C - 150^{\circ}C = 15^{\circ}C
$$

This provides the allowable increase to T_I resulting from internal power dissipation. Then, invert equation 2:

 $P_{D(max)} = \Delta T_{max} \div R_{\theta JA} = 15^{\circ}\text{C} \div 228^{\circ}\text{C/W} = 66 \text{ mW}$

Finally, invert equation 1 with respect to voltage:

$$
V_{\text{CC}(\text{est})} = P_{\text{D}(\text{max})} \div I_{\text{CC}(\text{max})} = 66 \text{ mW} \div 4 \text{ mA} = 16.4 \text{ V}
$$

The result indicates that, at T_A , the application and device can dissipate adequate amounts of heat at voltages \leq V_{CC(est)}.

Compare $V_{CC(est)}$ to $V_{CC(max)}$. If $V_{CC(est)} \leq V_{CC(max)}$, then reliable operation between $V_{CC(est)}$ and $V_{CC(max)}$ requires enhanced $R_{\theta JA}$. If $V_{CC(est)} \ge V_{CC(max)}$, then operation between $V_{CC(est)}$ and $V_{CC(max)}$ is reliable under these conditions.

Chopper-Stabilized Precision Hall-Effect Latches A1220, A1221,

Package LH, 3-Pin (SOT-23W)

For Reference Only – Not for Tooling Use

(Reference Allegro DWG-0000628, Rev. 1) NOT TO SCALE Dimensions in millimeters Dimensions exclusive of mold flash, gate burrs, and dambar protrusions Exact case and lead configuration at supplier discretion within limits shown

 0.40 ± 0.10

0.95 BSC

PCB Layout Reference View

All pads a minimum of 0.20 mm from all adjacent pads; adjust as necessary to meet application process requirements and PCB layout tolerances

Standard Branding Reference View 1

 $Line 1 = 3 character$

Line 1: Last 3 digits of Part Number

Branding scale and appearance at supplier discretion

Standard Branding Reference View 2

Line 1 = 3 characters

Line 1: Last 2 digits of Part Number, Temperature Code (letter)

Branding scale and appearance at supplier discretion

Chopper-Stabilized Precision Hall-Effect Latches A1220, A1221,

Package UA, 3-Pin SIP, Chopper Style

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Revision History

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